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CONFIRMATION NO. ATTORNEY DOCKET NO. FIRST NAMED INVENTOR 4986 4425-224 FILING DATE APPLICATION NO. Jung-Yu Hsieh 12/06/2001 10/002,978 EXAMINER 06/04/2002 LOWE HAUPTMAN GILMAN & BERNER, LLP 7590 LE, THAO X PAPER NUMBER Suite 310 1700 Diagonal Road Alexandria, VA 22314 ART UNIT 2814

DATE MAILED: 06/04/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

			1h
	Application No.	Applicant(s)	V*
	10/002,978	HSIEH ET AL.	
		Art Unit	
Office Action Summary	Examiner	2814	
The MAILING DATE of this communication	Thao X Le	eet with the correspondenc address -	-
The MAILING DATE of this communication	app ars on the		
A SHORTENED STATUTORY PERIOD FOR RE THE MAILING DATE OF THIS COMMUNICATIO - Extensions of time may be available under the provisions of 37 CFI - Extensions of time may be available under the provisions of 37 CFI - Extensions of time may be available under the provisions of 37 CFI - If the period for reply specified above is less than thirty (30) days, 2 - If NO period for reply is specified above, the maximum statutory pe - Failure to reply within the set or extended period for reply will, by s - Any reply received by the Office later than three months after the n - earned patent term adjustment. See 37 CFR 1.704(b).	PLY IS SET TO EXPIR IN. R 1.136(a). In no event, however, a reply within the statutory minimulariod will apply and will expire SIX tatute, cause the application to be nailing date of this communication	E 3 MONTH(S) FROM may a reply be timely filed m of thirty (30) days will be considered timely. (6) MONTHS from the mailing date of this communic	
1) Responsive to communication(s) filed on	This action is non-fina	ıl.	
6-VI I INC SCHOULS LUVY=:	_	There procedifical as to the time	rits is
3) Since this application is in condition for a closed in accordance with the practice u	nder Ex parte Quayle, 1	935 C.D. 11, 453 O.G. 213.	
Disposition of Claims 4) Claim(s) 1-19 is/are pending in the application of Claim (s) 1-19 is/are pending in the application of Claims	cation.		
4) Claim(s) 1-19 is/are perfulling in the approach 4a) Of the above claim(s) is/are with	thdrawn from considera	tion.	
4a) Of the above claim(s)			
5) Claim(s) is/are allowed.			
6) Claim(s) 1-19 is/are rejected.			
7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction	and/or election requires	ment.	
8) Claim(s) are subject to			
Application Papers 9) The specification is objected to by the Ex	kaminer.	Luck Evaminer	
9) The specification is objected to by the Example 10) The drawing(s) filed on is/are: a)[] accepted or b)∏ object	ed to by the Examinor.	
10) The drawing(s) filed on is/are: a) [Applicant may not request that any objection of the delivered of the delivere	on to the drawing(s) be he	Id in abeyance. See or or the Examiner.	•
in a correction tiled of	10, 1.		
earracted drawings are requi	Ca iii (Pr)	mon.	
12) The oath or declaration is objected to by	the Examiner.		
Priority under 35 U.S.C. §§ 119 and 120		or u.e. C. 8. 119/a)-(d) or (f).	
Priority under 35 U.S.C. §§ 119 and 120 13) Acknowledgment is made of a claim for	or foreign priority under	35 0.5.0. 8 113(0) (3) 3. (1)	
* - \ \ \ \ \ \ \ \ \ \ \ \ \ \			
	ocuments have been red	ceived.	
Certified copies of the priority do	ocuments have been re	ceived in Application No have been received in this National S	stage
Coming of the certified copies of	the priority documents	17 2(a))	•
* See the attached detailed Office action	domestic priority under	· 35 U.S.C. § 119(e) (to a provisional	application).
a) The translation of the foreign lang	nuage provisional applic	ation has been received.	
a) The translation of the foreign lang	or domestic priority unde	_{rr} 35 U.S.C. §§ 120 and/or 121.	
Attachment(s)		- Cummon (PTO-413) Paper Not	(s) O-152)
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (P' 3) Information Disclosure Statement(s) (PTO-1449) Page 1	10-940)	Notice of Informal Patent Application (1) Other:	
3) Information Disclosure Statement(3) (Part o	of Paper No. 2

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DETAILED ACTION

Drawings

The drawings are objected to as failing to comply with 37 CFR 1.84(p)(5) because they 1. do not include the following reference sign(s) mentioned in the description: 212 and 206. A proposed drawing correction or corrected drawings are required in reply to the Office action to avoid abandonment of the application. The objection to the drawings will not be held in abeyance.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the 2. basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (1) an application for patent, published under section 122(b), by another filed in the United States before the (e) the invention was described ininvention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effect under this subsection of a national application published under section 122(b) only if the international application designating the United States was published under Article 21(2)(a) of such
- (2) a patent granted on an application for patent by another filed in the United States before the invention by the treaty in the English language; or applicant for patent, except that a patent shall not be deemed filed in the United States for the purposes of this subsection based on the filing of an international application filed under the treaty defined in section 351(a).
- Claims 1-19 are rejected under 35 U.S.C. 102(e) as being anticipated by US Patent 3. 6,163,050 Hisatomi et al.

Regarding to claim 1, Hisatomi discloses a method for forming an oxide-nitrideoxide structure fig. 2 in one chamber, the method comprising the steps of: providing a substrate 33, column 6 line 35, forming a first oxide layer 36-1, column 6 line 44, on substrate, forming a first buffer layer 36-4, column 7 line 38, on first oxide layer, forming a silicon nitride layer 36-2, column 6 line 50, on first buffer layer, forming a second

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buffer layer 36-5, column 7 line 41, on silicon nitride, and forming a second oxide layer 36-3, column 6 line 56, on second buffer layer.

Regarding to claim 2, 8, 12, 18, Hisatomi discloses a method for forming an oxide-nitride-oxide structure wherein first and second oxide layers are formed by introducing silane gas and nitrogen oxide gas, column 6 line lines 40-41.

Regarding to claim 3, 4, 6, 7, 13, 14, 16, 17, Hisatomi discloses a method for forming an oxide-nitride-oxide structure wherein first and second buffer layer is silicon oxynitride (SiON) layer, column 7 line 38, by introducing silane, nitrogen oxide and ammonia gas, column 7 line 36-37.

Regarding to claim 5, 8, 15, Hisatomi discloses a method for forming an oxidenitride-oxide structure wherein silicon nitride layer is formed by introducing silane and ammonia, column 6 lines 45-46

Regarding to claim 9, Hisatomi discloses a method for forming an oxide-nitride-oxide structure is formed in one wafer, because silicon substrate, column 6 line 35, is inherently a wafer.

Regarding to claim 10, Hisatomi discloses a method for forming an oxide-nitride-oxide structure fig. 2 in one chamber, the method comprising the steps of: providing a substrate 33, column 6 line 35, forming a first oxide layer 36-1, column 6 line 44, on substrate, forming a first buffer layer 36-4, column 7 line 38, on first oxide layer, forming a silicon nitride layer 36-2, column 6 line 50, on first buffer layer, forming a second buffer layer 36-5, column 7 line 41, on silicon nitride, and forming a second oxide layer 36-3, column 6 line 56, on second buffer layer, wherein above-mention layer is formed in

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one chamber and one wafer, because inherent continuous process, column 6 line 45, 57 column 7 line 36.

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Regarding to claim 11, Hisatomi discloses a method for forming an ONO structure is formed by low-pressure chemical vapor deposition (LPLVD) method, column 6 line 37.

Regarding to claim 19, as discussed above claims 1-18, Hisatomi discloses all the limitations in claimed 19.

Conclusion

- The prior art made of record and not relied upon is considered pertinent to applicant's 4. disclosure:
 - a) US Patent 6,358,864 to Chang et al.
 - b) US Patent 5,714,399 to Hisatomi et al.
 - c) US Pub 2002/0006706 to Nishida et al.
 - d) US Pub 2002/0048969 to Suzuki et al.
 - Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thao X Le whose telephone number is 703-306-0208. The examiner can normally be reached on M-F from 8:00 AM - 4:30 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Olik Chaudhuri can be reached on 703-306-2794. The fax phone numbers for the organization where this application or proceeding is assigned are 703-308-7722 for regular communications and 703-308-7722 for After Final communications.

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Any inquiry of a general nature or relating to the status of this application or proceeding Art Unit: 2814 should be directed to the receptionist whose telephone number is 703-308-0956.

Thao X. Le May 17, 2002

PHAT X. CAO PRIMARY EXAMINER